TE Internal #: 2294408-1

zSFP+, Cage Assembly, Signal, Operating Temperature Range -40 -

85 °C [-40 - 185 °F], Data Rate (Max) 32 Gb/s, 8 Ports

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Connectors > Pluggable IO Connectors & Cages > zSFP+ Cage Assembly: EMI Springs



Pluggable I/O Product Type: Cage Assembly

Sealable: No

Circuit Application: Signal

Operating Temperature Range: -40 - 85 °C [-40 - 185 °F]

Data Rate (Max): 32 Gb/s

All zSFP+ Cage Assembly: EMI Springs (24)

Features

Product Type Features

Thermal Accessory Type Included	Heat Sink
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Sealable	No
Form Factor	zSFP+

Configuration Features

Lightpipe Style	Standard
Number of Ports	8
Port Matrix Configuration	1 x 8

Electrical Characteristics

	Data Rate (Max)	32 Gb/s
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Body Features

Heat Sink Finish	Electroless Nickel
	.358 in
Heat Sink Height Class	Networking Short
Heat Sink Style	Pin

Termination Features



Tamainatian Daat 9 Tail Languth	2.05
Termination Post & Tail Length	2.05 mm[.081 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Housing Features	
Cage Material	Nickel Silver Alloy
Dimensions	
PCB Thickness (Recommended)	2.25 mm[.089 in]
Usage Conditions	
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Heat Sink Compatible	Yes
Circuit Application	Signal
Packaging Features	
Packaging Method	Tray
Other	
Included Lightpipe	Yes

Product Compliance

EMI Containment Feature Type

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Internal/External EMI Springs

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these



limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





QSFP28-Four SFP+ Cable Assembly:

26 AWG

30 AWG







AWG















Customers Also Bought













RQ 0603 17K8 0.1% 10PPM 5K RL







Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2294408-1_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2294408-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2294408-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions**of use.

Datasheets & Catalog Pages

zSFP+ Interconnect Brochure

English